

Docket No. 243433US2SX



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Koji YAMAKAWA, et al.

SERIAL NUMBER: 10/673,247

ATTN: APPLICATION BRANCH

FILING DATE: September 30, 2003

FOR: SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

FILING OF DECLARATION UNDER 37 CFR 1.53(f)

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Responsive to the notification dated January 2, 2004, and in accordance with the provisions of 37 CFR 1.53(f), Applicants submit herewith a Rule 63 Declaration. The required fee was paid at the time of filing the application.

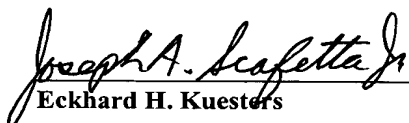
The Declaration enclosed herewith, attached to the specification, is believed to adequately identify the above-identified application in accordance with 37 CFR 1.63, as set forth in MPEP Section 601.01.

The undersigned hereby states that the specification to which the Declaration is attached is a true copy of the specification, and any amendments thereto, as originally filed in the Patent Office in order to obtain a filing date.

In light of the foregoing, this application is deemed to be in proper condition for examination and such favorable action is earnestly solicited.

Respectfully Submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.


Eckhard H. Kuesters

Registration No. 28,870

Joseph A. Scafetta, Jr.

Registration No. 26, 803

Customer Number

22850

Tel. (703) 413-3000

Fax. (703) 413-2220

(OSMMN 05/03)

I:\USER\MICKS\243S\243433US FILING DEC.DOC



DECLARATION FOR PATENT APPLICATION

(03S0639)

As a below named inventor, I declare that my residence, mailing address and citizenship are as stated below above my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

the specification of which (check applicable box(es))

☒ is attached hereto.

☐ was filed on _____ as United States Application No.

or PCT International Application No.

☐ and was amended on _____

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 35 U.S.C. 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

None

I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional applications listed below.

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s) or 35 U.S.C. 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application or PCT International application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application.

I hereby appoint as my attorneys, with full power of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: the registrants of Oblon, Spivak, McClelland, Maier & Neustadt, P.C., Fourth Floor, 1755 Jefferson Davis Highway, Arlington, Virginia 22202, Customer No. 22850, or any one of them. Send correspondence to Oblon, Spivak, McClelland, Maier & Neustadt, P.C., Fourth Floor, 1755 Jefferson Davis Highway, Arlington, Virginia 22202.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

DECLARATION FOR PATENT APPLICATION

(03S0639)

[1st Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Tokyo, Japan

Citizenship: Japan


Koji Yamakawa

Sep. 29, 2003
Date:

[2nd Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Yokohama-shi, Japan

Citizenship: Japan


Katsuaki Natori

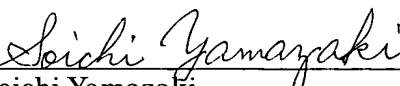
Oct. 21, 2003
Date:

[3rd Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Yokohama-shi, Japan

Citizenship: Japan


Soichi Yamazaki

Sep. 17, 2003
Date:

[4th Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Yokohama-shi, Japan

Citizenship: Japan


Osamu Arisumi

Sep. 29, 2003
Date:

DECLARATION FOR PATENT APPLICATION

(03S0639)

[5th Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Yokohama-shi, Japan

Citizenship: Japan

Hiroshi Itokawa

Hiroshi Itokawa

Oct. 21, 2003

Date:

[6th Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Yokohama-shi, Japan

Citizenship: Japan

Hiroyuki Kanaya

Hiroyuki Kanaya

Sep 18, 2003

Date:

[7th Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Yokohama-shi, Japan

Citizenship: Japan

Kazuhiro Tomioka

Kazuhiro Tomioka

Oct. 22, 2003

Date:

[8th Inventor]

Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Tokyo, Japan

Citizenship: Japan

Keisuke Nakazawa

Keisuke Nakazawa

Sep. 26, 2003

Date:

DECLARATION FOR PATENT APPLICATION

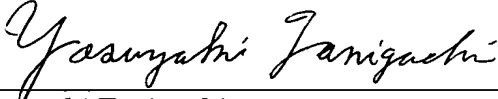
(03S0639)

[9th Inventor]

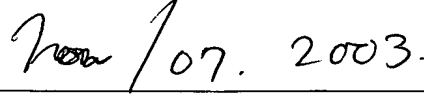
Mailing Address: c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome,
Minato-ku, Tokyo 105-8001, Japan

Residence Address: Tokyo, Japan

Citizenship: Japan



Yasuyuki Taniguchi

 107. 2003.

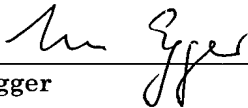
Date:

[10th Inventor]

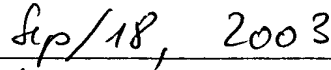
Mailing Address: 3-20-14, Higashigotanda, Shinagawa-ku, Tokyo, Japan

Residence Address: Tokyo, Japan

Citizenship: GERMAN



Uli Egger

 Sep/18, 2003

Date: